Presettable Divide-By-N Counter

The MC14018B contains five Johnson counter stages which are asynchronously presettable and resettable. The counters are synchronous, and increment on the positive going edge of the clock.

Presetting is accomplished by a logic 1 on the preset enable input. Data on the Jam inputs will then be transferred to their respective \overline{Q} outputs (inverted). A logic 1 on the reset input will cause all \overline{Q} outputs to go to a logic 1 state.

Division by any number from 2 to 10 can be accomplished by connecting appropriate \overline{Q} outputs to the data input, as shown in the Function Selection table. Anti–lock gating is included in the MC14018B to assure proper counting sequence.

Features

- Fully Static Operation
- Schmitt Trigger on Clock Input
- Capable of Driving Two Low-Power TTL Loads or One Low-Power Schottky TTL Load Over the Rated Temperature Range
- Pin-for-Pin Replacement for CD4018B
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- This Device is Pb-Free and is RoHS Compliant

MAXIMUM RATINGS (Voltages Referenced to V_{SS})

Symbol	Parameter	Value	Unit
V_{DD}	DC Supply Voltage Range	-0.5 to +18.0	V
V _{in} , V _{out} Input or Output Voltage Range (DC or Transient)		-0.5 to V _{DD} + 0.5	V
I _{in} , I _{out}	Input or Output Current (DC or Transient) per Pin	±10	mA
P _D	Power Dissipation, per Package (Note 1)	500	mW
T _A	Ambient Temperature Range	-55 to +125	°C
T _{stg}	Storage Temperature Range	-65 to +150	°C
TL	Lead Temperature (8–Second Soldering)	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: "D/DW" Packages: -7.0 mW/°C From 65°C To 125°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.



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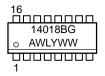


SOIC-16 D SUFFIX CASE 751B

PIN ASSIGNMENT

D _{in} [1●	16] V _{DD}
JAM 1	2	15] R
JAM 2 [3	14] C
<u>Q</u> 2 [4	13] Q 5
<u>Q</u> 1 [5	12	JAM 5
<u>Q</u> 3 [6	11] Q 4
JAM 3	7	10] PE
V _{SS} [8	9] JAM 4

MARKING DIAGRAM



A = Assembly Location

 $\begin{array}{ll} \text{WL, L} &= \text{Wafer Lot} \\ \text{YY, Y} &= \text{Year} \\ \text{WW, W} &= \text{Work Week} \\ \text{G} &= \text{Pb-Free Indicator} \end{array}$

FUNCTIONAL TRUTH TABLE

Clock	Reset	Preset Enable	Jam Input	Qn
7	0	0	Х	Qn
	0	0	Х	\overline{D}_{n}^*
Х	0	1	0	1
Х	0	1	1	0
Χ	1	X	X	1

*D_n is the Data input for that stage. Stage 1 has Data brought out to Pin 1.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

			_55°C 25°C		25°C		12	5°C			
Characteristic		Symbol	V _{DD} Vdc	Min	Max	Min	Typ (Note 2)	Max	Min	Max	Unit
Output Voltage V _{in} = V _{DD} or 0	"0" Level	V _{OL}	5.0 10 15	- - -	0.05 0.05 0.05	- - -	0 0 0	0.05 0.05 0.05	- - -	0.05 0.05 0.05	Vdc
$V_{in} = 0$ or V_{DD}	"1" Level	V _{OH}	5.0 10 15	4.95 9.95 14.95	- - -	4.95 9.95 14.95	5.0 10 15	- - -	4.95 9.95 14.95	- - -	Vdc
Input Voltage $(V_O = 4.5 \text{ or } 0.5 \text{ Vdc})$ $(V_O = 9.0 \text{ or } 1.0 \text{ Vdc})$ $(V_O = 13.5 \text{ or } 1.5 \text{ Vdc})$	"0" Level	V _{IL}	5.0 10 15	- - -	1.5 3.0 4.0	- - -	2.25 4.50 6.75	1.5 3.0 4.0	- - -	1.5 3.0 4.0	Vdc
$(V_O = 0.5 \text{ or } 4.5 \text{ Vdc})$ $(V_O = 1.0 \text{ or } 9.0 \text{ Vdc})$ $(V_O = 1.5 \text{ or } 13.5 \text{ Vdc})$	"1" Level	V _{IH}	5.0 10 15	3.5 7.0 11	- - -	3.5 7.0 11	2.75 5.50 8.25	- - -	3.5 7.0 11	- - -	Vdc
Output Drive Current $ (V_{OH} = 2.5 \text{ Vdc}) $ $ (V_{OH} = 4.6 \text{ Vdc}) $ $ (V_{OH} = 9.5 \text{ Vdc}) $ $ (V_{OH} = 13.5 \text{ Vdc}) $	Source	I _{OH}	5.0 5.0 10 15	-3.0 -0.64 -1.6 -4.2		-2.4 -0.51 -1.3 -3.4	-4.2 -0.88 -2.25 -8.8		-1.7 -0.36 -0.9 -2.4		mAdc
$(V_{OL} = 0.4 \text{ Vdc})$ $(V_{OL} = 0.5 \text{ Vdc})$ $(V_{OL} = 1.5 \text{ Vdc})$	Sink	I _{OL}	5.0 10 15	0.64 1.6 4.2	- - -	0.51 1.3 3.4	0.88 2.25 8.8	- - -	0.36 0.9 2.4	- - -	mAdc
Input Current		I _{in}	15	_	±0.1	_	±0.00001	±0.1	_	±1.0	μAdc
Input Capacitance (V _{in} = 0)		C _{in}	-	-	-	-	5.0	7.5	_	-	pF
Quiescent Current (Per Package)		I _{DD}	5.0 10 15	- - -	5.0 10 20	- - -	0.005 0.010 0.015	5.0 10 20	_ _ _	150 300 600	μAdc
Total Supply Current (Notes 3 & 4) (Dynamic plus Quiescent, Per Package) (C _L = 50 pF on all outputs, all buffers switching)		lτ	5.0 10 15			$I_T = (0$).3 μΑ/kHz) f).7 μΑ/kHz) f 1.0 μΑ/kHz) f	+ I _{DD}	•	,	μAdc

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
 The formulas given are for the typical characteristics only at 25°C.
 To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk}$$

where: I_T is in μA (per package), C_L in pF, $V = (V_{DD} - V_{SS})$ in volts, f in kHz is input frequency, and k = 0.001.

ORDERING INFORMATION

Device	Package	Shipping [†]
MC14018BDG	SOIC-16 (Pb-Free)	48 Units / Rail
NLV14018BDG*	SOIC-16 (Pb-Free)	48 Units / Rail
MC14018BDR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

SWITCHING CHARACTERISTICS (Note 5) ($C_L = 50 \text{ pF}, T_A = 25^{\circ}C$)

			All Types			
Characteristic	Symbol	V _{DD} Vdc	Min	Typ (Note 6)	Max	Unit
Output Rise and Fall Time $t_{TLH}, t_{THL} = (1.35 \text{ ns/pF}) \text{ C}_L + 32 \text{ ns}$ $t_{TLH}, t_{THL} = (0.6 \text{ ns/pF}) \text{ C}_L + 20 \text{ ns}$ $t_{TLH}, t_{THL} = (0.4 \text{ ns/pF}) \text{ C}_L + 20 \text{ ns}$	t _{TLH} , t _{THL}	5.0 10 15	- - -	100 50 40	200 100 80	ns
Propagation Delay Time Clock to \overline{Q} t_{PLH} , t_{PHL} = (0.90 ns/pF) C_L + 265 ns t_{PLH} , t_{PHL} = (0.36 ns/pF) C_L + 102 ns t_{PLH} , t_{PHL} = (0.26 ns/pF) C_L + 72 ns	t _{PLH} , t _{PHL}	5.0 10 15	- - -	310 120 85	620 240 170	ns
Reset to \overline{Q} $t_{PLH} = (0.90 \text{ ns/pF}) C_L + 325 \text{ ns}$ $t_{PLH} = (0.36 \text{ ns/pF}) C_L + 132 \text{ ns}$ $t_{PLH} = (0.26 \text{ ns/pF}) C_L + 81 \text{ ns}$		5.0 10 15	- - -	370 150 100	740 300 200	ns
Preset Enable to \overline{Q} t_{PLH} , t_{PHL} = (0.90 ns/pF) C_L + 325 ns t_{PLH} , t_{PHL} = (0.36 ns/pF) C_L + 132 ns t_{PLH} , t_{PHL} = (0.26 ns/pF) C_L + 81 ns		5.0 10 15	- - -	370 150 100	740 300 200	ns
Setup Time Data (Pin 1) to Clock	t _{su}	5.0 10 15	200 100 80	0 0 0	- - -	ns
Jam Inputs to Preset Enable		5.0 10 15	200 100 80	0 0 0	- - -	ns
Data (Jam Inputs)-to-Preset Enable Hold Time	t _h	5.0 10 15	540 500 480	270 250 240	- - -	ns
Clock Pulse Width	t _{WH}	5.0 10 15	400 200 160	200 100 80	- - -	ns
Reset or Preset Enable Pulse Width	t _{WH}	5.0 10 15	290 130 110	145 65 55	- - -	ns
Clock Rise and Fall Time	t _{TLH} , t _{THL}	5.0 10 15		No Limit		ns
Clock Pulse Frequency	f _{cl}	5.0 10 15	- - -	2.5 6.5 8.0	1.25 3.25 4.0	MHz

- 5. The formulas given are for the typical characteristics only at 25°C.
 6. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

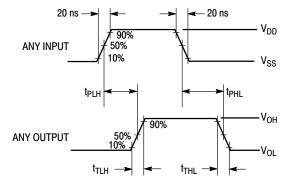
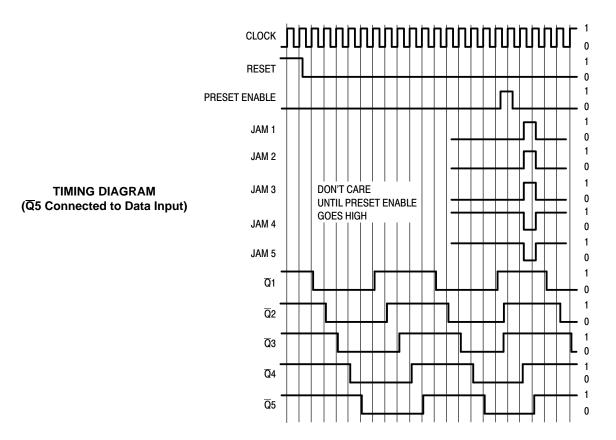


Figure 1. Switching Time Waveforms



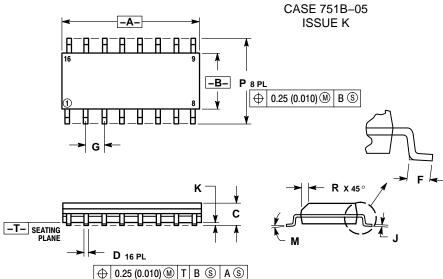
FUNCTION SELECTION

Counter Mode	Connect Data Input (Pin 1) to:	Comments						
Divide by 10 Divide by 8 Divide by 6 Divide by 4 Divide by 2	\overline{Q5} \overline{Q4} \overline{Q3} \overline{Q2} \overline{Q1}	No external components needed.			LO	GIC DIAGF	RAM	
Divide by 9 Divide by 7 Divide by 5 Divide by 3	Q5 • Q4 Q4 • Q3 Q3 • Q2 Q2 • Q1	Gate package needed to provide AND function. Counter Skips all 1's state		JAM 1	JAM 2	JAM 3	JAM 4	JAM 5 12 0
			CLOCK SHAPER	D S Q C R P	D S Q C Q R P	D S Q C R P	D S Q C R P	D S Q C R P
	PRESET E		V _{DD} = PIN 16 V _{SS} = PIN 8	5 5		7 {	111	13
				3 J	0 1 \q		۱ ۱	∏ 13 ∏ 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0

PACKAGE DIMENSIONS

SOIC-16 **D SUFFIX**

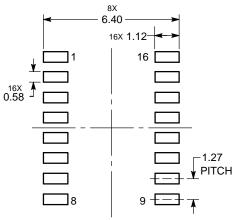
PLASTIC SOIC PACKAGE CASE 751B-05



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INC	HES					
DIM	MIN MAX		MIN	MAX					
Α	9.80	10.00	0.386	0.393					
В	3.80	4.00	0.150	0.157					
С	1.35	1.75	0.054	0.068					
D	0.35	0.49	0.014	0.019					
F	0.40	1.25	0.016	0.049					
G	1.27	BSC	0.050 BSC						
J	0.19	0.25	0.008	0.009					
K	0.10	0.25	0.004	0.009					
M	0 °	7°	0 °	7°					
P	5.80	6.20	0.229	0.244					
R	0.25	0.50	0.010	0.019					

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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